MOSFET

Metal Oxide Semiconductor Field Effect Transistor

CFDA Automotive

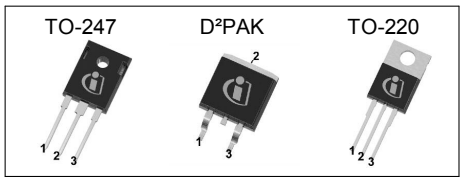
650V CoolMOS™ CFDA Power Transistor
IPx65R110CFDA

Data Sheet

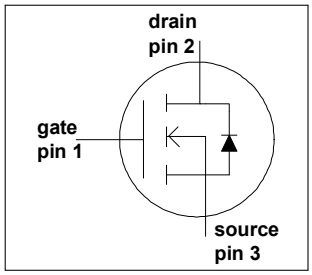
Rev. 2.0
Final

Automotive

1 Description



CoolMOS™ is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies. 650V CoolMOS™ CFDA series combines the experience of the leading SJ MOSFET supplier with high class innovation. The resulting devices provide all benefits of a fast switching SJ MOSFET while offering an extremely fast and robust body diode. This combination of extremely low switching, commutation and conduction losses together with highest robustness make especially resonant switching applications more reliable, more efficient, lighter, and cooler.



Features

- Ultra-fast body diode
- Very high commutation ruggedness
- Extremely low losses due to very low FOM Rdson*Qg and Eoss
- Easy to use/drive
- Qualified according to AEC Q101
- Green package (RoHS compliant), Pb-free plating, halogen free for mold compound

Applications

650V CoolMOS™ CFDA is designed for switching applications.

Table 1 Key Performance Parameters

Parameter	Value	Unit
V_{DS}	650	V
RDS(on),max	0.11	Ω
Qg,typ	118	nC
ID,pulse	99.6	A
Eoss @ 400V	9.2	µJ
Body diode di/dt	900	A/µs
Qrr	0.8	µC
trr	150	ns
Irrm	8.3	A

Type / Ordering Code	Package	Marking	Related Links
IPW65R110CFDA	PG-TO 247	65F6110A	-
IPB65R110CFDA	PG-TO 263		
IPP65R110CFDA	PG-TO 220		

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2 Maximum ratings

at T_j = 25°C, unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Continuous drain current[1]	I_D			31.2	A	T_C = 25°C
				19.7		T_C = 100°C
Pulsed drain current[2]	$I_{D,pulse}$			99.6	A	T_C = 25°C
Avalanche energy, single pulse	E_{AS}			845	mJ	I_D = 6.2A, V_{DD} = 50V (see table 19)
Avalanche energy, repetitive	E_{AR}			1.3	mJ	I_D = 6.2A, V_{DD} = 50V
Avalanche current, repetitive	I_{AR}			6.2	A	
MOSFET dv/dt ruggedness	dv/dt			50	V/ns	V_{DS} = 0 ... 400V
Gate source voltage	V_{GS}	-20		20	V	static
		-30		30		AC (f > 1 Hz)
Power dissipation (non FullPAK, SMD) TO-247, TO-220, D²PAK	P_{tot}			277.8	W	T_C = 25°C
Operating and storage temperature	T_j, T_{stg}	-40		150	°C	
Mounting torque (non FullPAK) TO-247, TO-220				60	Ncm	M3 and M3.5 screws
Continuous diode forward current	I_S			31.2	A	T_C = 25°C
Diode pulse current	$I_{S,pulse}$			99.6	A	T_C = 25°C
Reverse diode dv/dt[3]	dv/dt			50	V/ns	V_{DS} = 0 ... 400V, $I_{SD} \le I_D$, T_j = 25°C (see table 17)
Maximum diode commutation speed	di_f/dt			900	A/µs	

[1] Limited by $T_{j\,max}$.
[2] Pulse width t_p limited by $T_{j\,max}$
[3] Identical low side and high side switch with identical R_G

3 Thermal characteristics

Table 3 Thermal characteristics TO-247, TO-220

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Thermal resistance, junction - case	R_{thJC}			0.45	K/W	
Thermal resistance, junction - ambient	R_{thJA}			62	K/W	leaded
Soldering temperature, wavesoldering only allowed at leads	T_{sold}			260	°C	1.6 mm (0.063 in.) from case for 10s

Table 4 Thermal characteristics D²PAK

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Thermal resistance, junction - case	R_{thJC}			0.45	K/W	
Thermal resistance, junction - ambient[1)]	R_{thJA}			62	K/W	SMD version, device on PCB, minimal footprint
			35			SMD version, device on PCB, 6cm² cooling area
Soldering temperature, wave- & reflowsoldering allowed	T_{sold}			260	°C	reflow MSL

[1)] Device on 40mm*40mm*1.5mm one layer epoxy PCB FR4 with 6cm² copper area (thickness 70µm) for drain connection. PCB is vertical without air stream cooling.

4 Electrical characteristics

at T_j = 25°C, unless otherwise specified

Table 5 Static characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Drain-source breakdown voltage[1]	$V_{(BR)DSS}$	650			V	V_{GS} = 0V, I_D = 1mA
Gate threshold voltage	$V_{GS(th)}$	3.5	4	4.5	V	V_{DS} = V_{GS}, I_D = 1.3mA
Zero gate voltage drain current	I_{DSS}			1.5	µA	V_{DS} = 650V, V_{GS} = 0V, T_j = 25°C
			400			V_{DS} = 650V, V_{GS} = 0V, T_j = 150°C
Gate-source leakage current	I_{GSS}			100	nA	V_{GS} = 20V, V_{DS} = 0V
Drain-source on-state resistance	$R_{DS(on)}$		0.099	0.11	Ω	V_{GS} = 10V, I_D = 12.7A, T_j = 25°C
			0.257			V_{GS} = 10V, I_D = 12.7A, T_j = 150°C
Gate resistance	R_G		1.3		Ω	f = 1MHz, open drain

Table 6 Dynamic characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Input capacitance	C_{iss}		3240		pF	V_{GS} = 0V, V_{DS} = 100V, f = 1MHz
Output capacitance	C_{oss}		160		pF	
Effective output capacitance, energy related[2]	$C_{o(er)}$		120		pF	V_{GS} = 0V, V_{DS} = 0 ... 400V
Effective output capacitance, time related[3]	$C_{o(tr)}$		553		pF	I_D = constant, V_{GS} = 0V, V_{DS} = 0 ... 400V
Turn-on delay time	$t_{d(on)}$		16		ns	V_{DD} = 400V, V_{GS} = 13V, I_D = 19.1A, R_G = 1.8Ω (see table 18)
Rise time	t_r		11		ns	
Turn-off delay time	$t_{d(off)}$		68		ns	
Fall time	t_f		6		ns	

Table 7 Gate charge characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Gate to source charge	Q_{gs}		21		nC	V_{DD} = 480V, I_D = 19.1A, V_{GS} = 0 to 10V
Gate to drain charge	Q_{gd}		64		nC	
Gate charge total	Q_g		118		nC	
Gate plateau voltage	$V_{plateau}$		6.4		V	

[1] For applications with applied blocking voltage > 65% of the specified blocking voltage, we recommend to evaluate the impact of the cosmic radiation effect in early design phase. For assessment please contact local Infineon sales office.
[2] $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V
[3] $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V

Table 8 Reverse diode characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Diode forward voltage	V_{SD}		0.9		V	V_{GS} = 0V, I_F = 19.1A, T_j = 25°C
Reverse recovery time	t_{rr}		150		ns	V_R = 400V, I_F = 19.1A, di_F/dt = 100A/µs (see table 17)
Reverse recovery charge	Q_{rr}		0.8		µC	
Peak reverse recovery current	I_{rrm}		8.3		A	

5 Electrical characteristics diagrams

Table 9

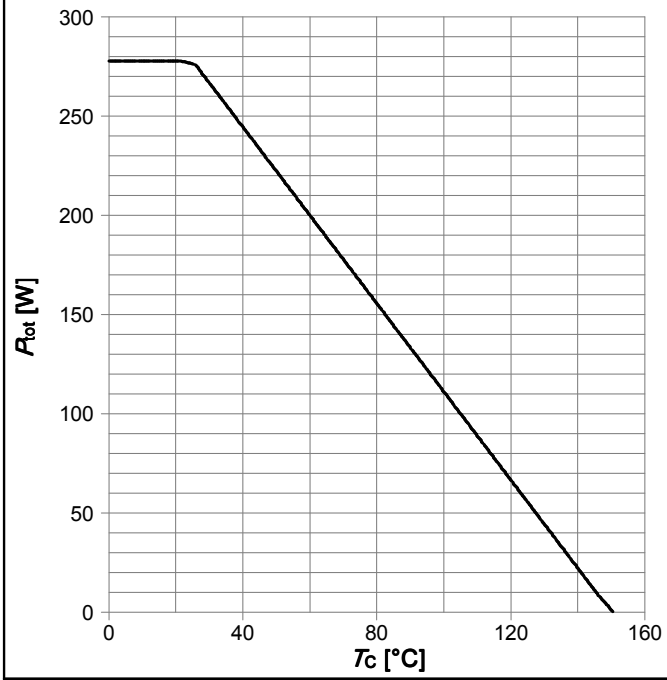
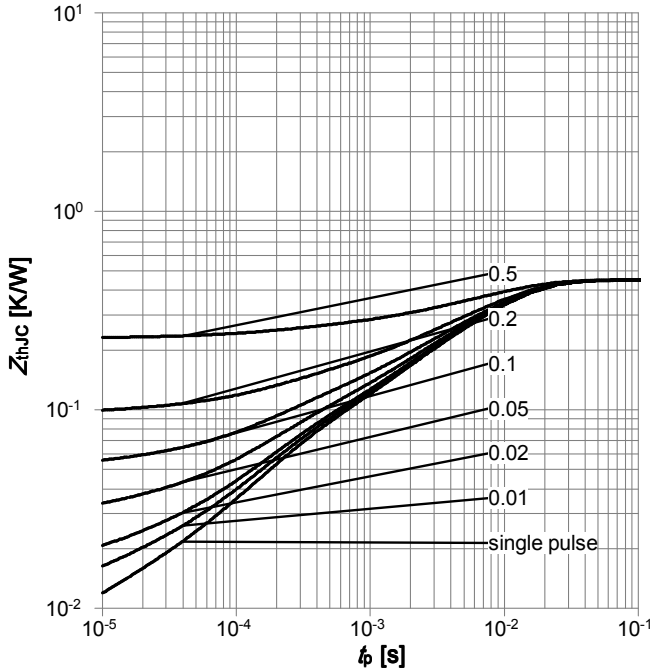
Power dissipation	Max. transient thermal impedance
	
$P_{tot}=f(T_C)$	$Z_{thJC}=f(t_P)$; parameter: $D=t_p/T$

Table 10

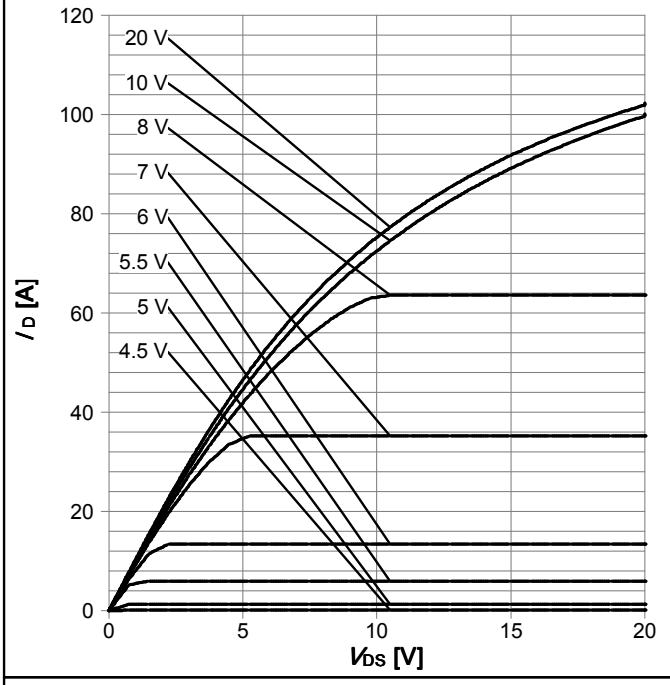
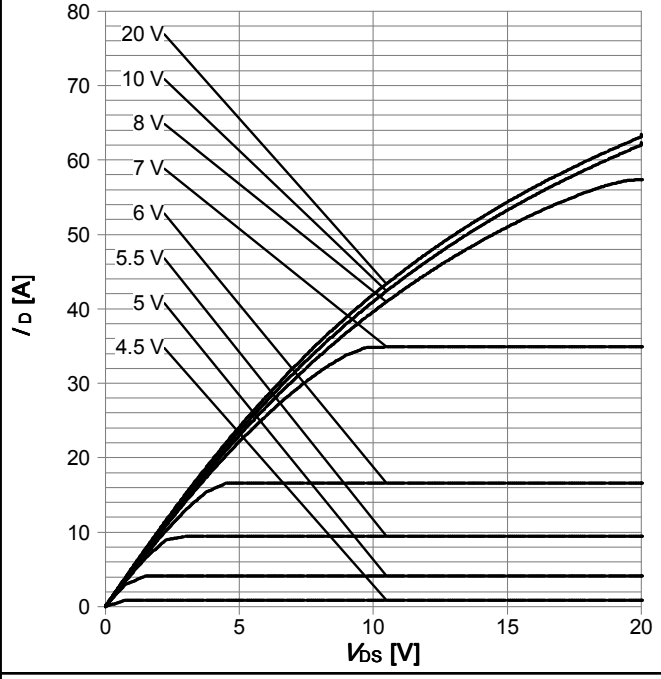
Typ. output characteristics	Typ. output characteristics
	
$I_D=f(V_{DS})$; $T_j=25$ °C; parameter: V_{GS}	$I_D=f(V_{DS})$; $T_j=125$ °C; parameter: V_{GS}

Table 11

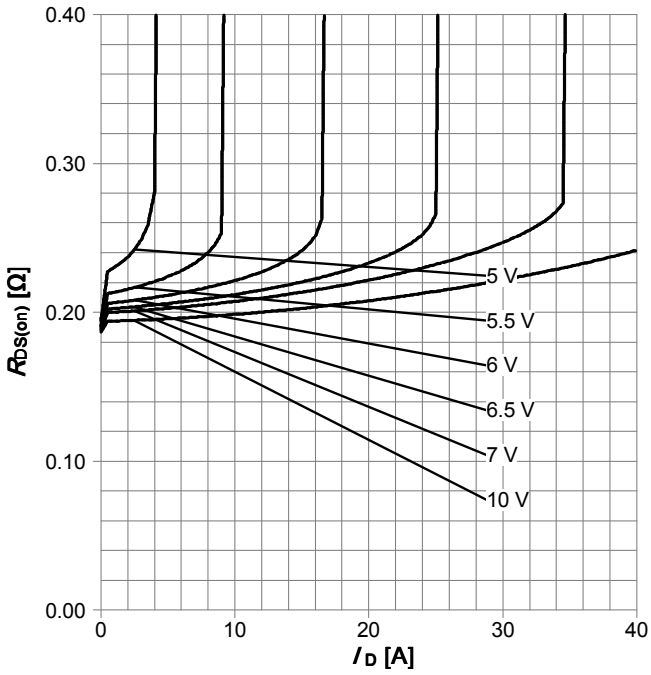
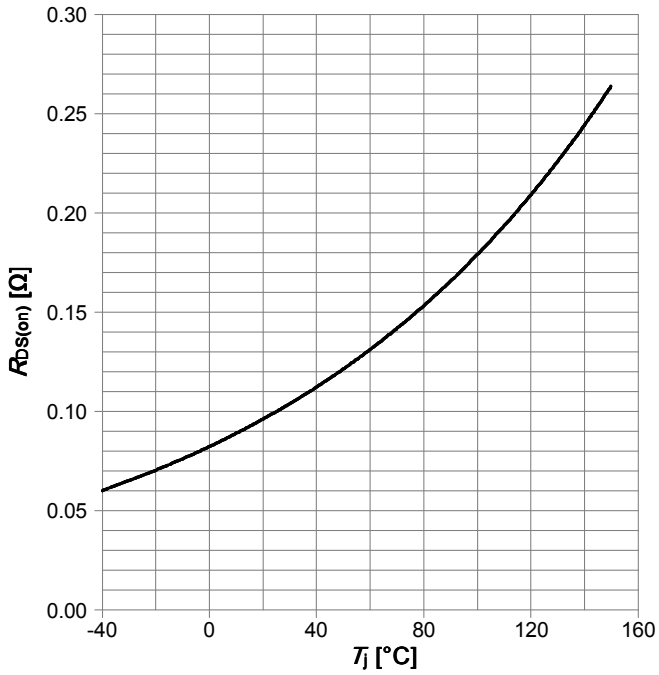
Typ. drain-source on-state resistance	Typ. drain-source on-state resistance
	
$R_{DS(on)}=f(I_D)$; T_j=125 °C; parameter: V_{GS}	$R_{DS(on)}=f(T_j)$; I_D=18.1 A; V_{GS}=10 V

Table 12

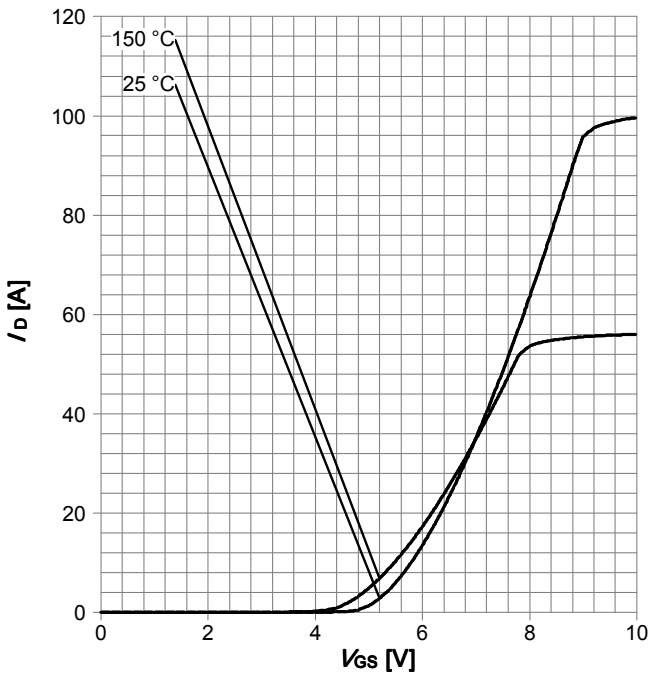
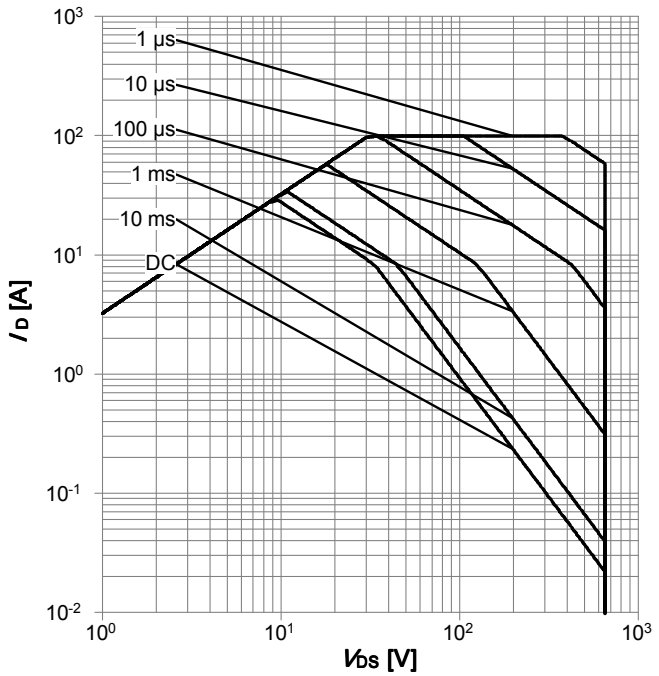
Typ. transfer characteristics	Safe operating area
	
$I_D=f(V_{GS})$; $\lvert V_{DS}\rvert>2\lvert I_D\rvert R_{DS(on)max}$; parameter: T_j	$I_D=f(V_{DS})$; T_C=25 °C; D=0; parameter: t_p

Table 13

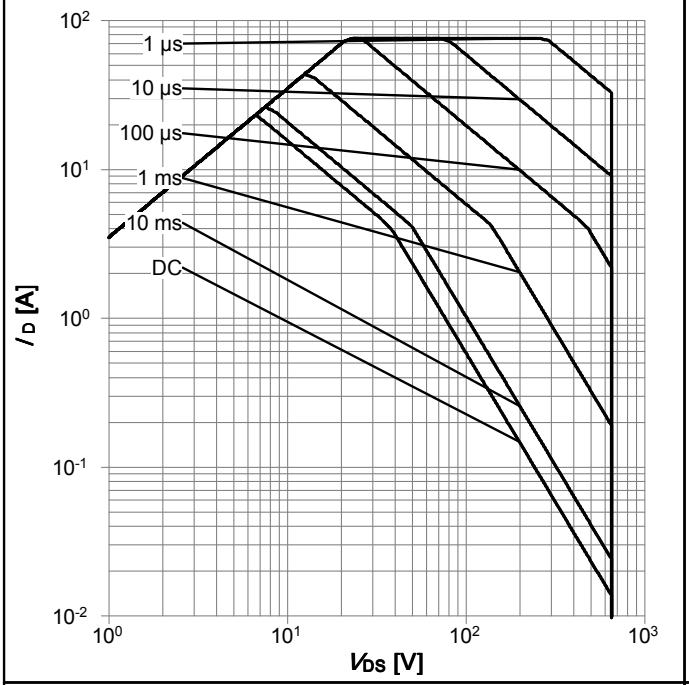
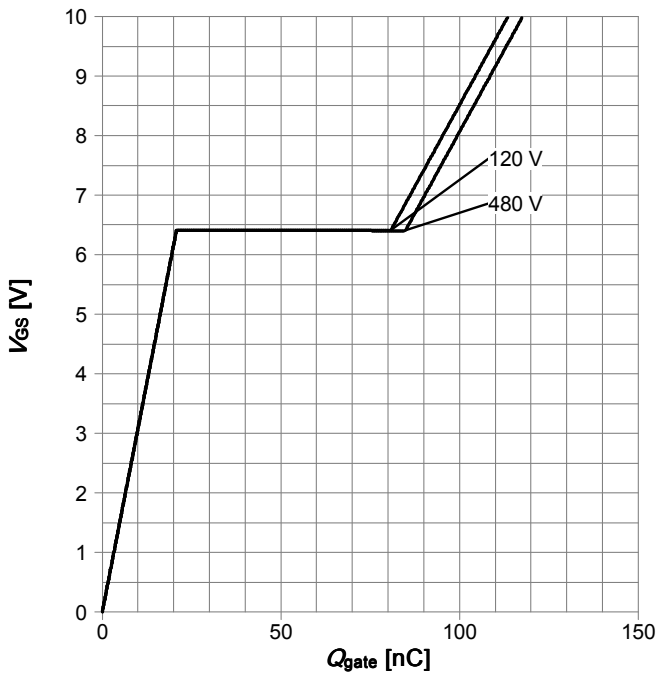
Safe operating area	Typ. gate charge
	
I_D=f(V_{DS}); T_C=80 °C; D=0; parameter: t_p	V_{GS}=f(Q_{gate}); I_D=19.2 A pulsed; parameter: V_{DD}

Table 14

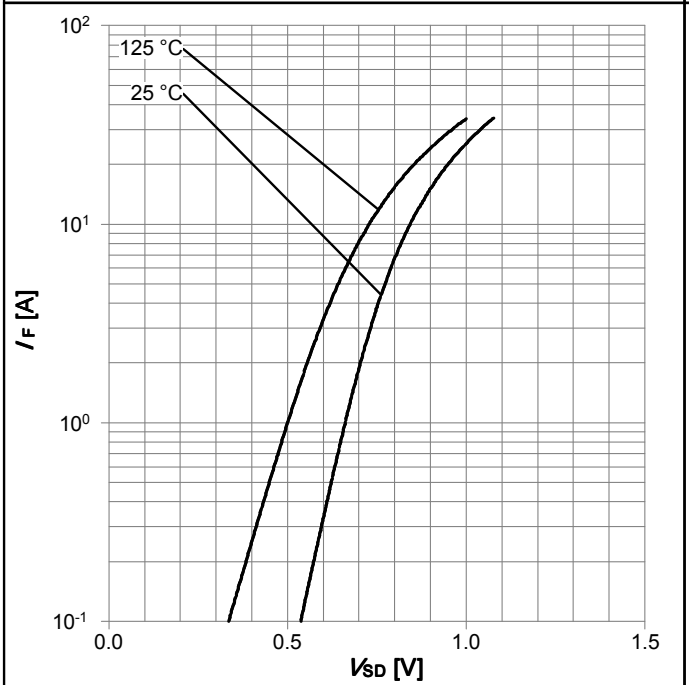
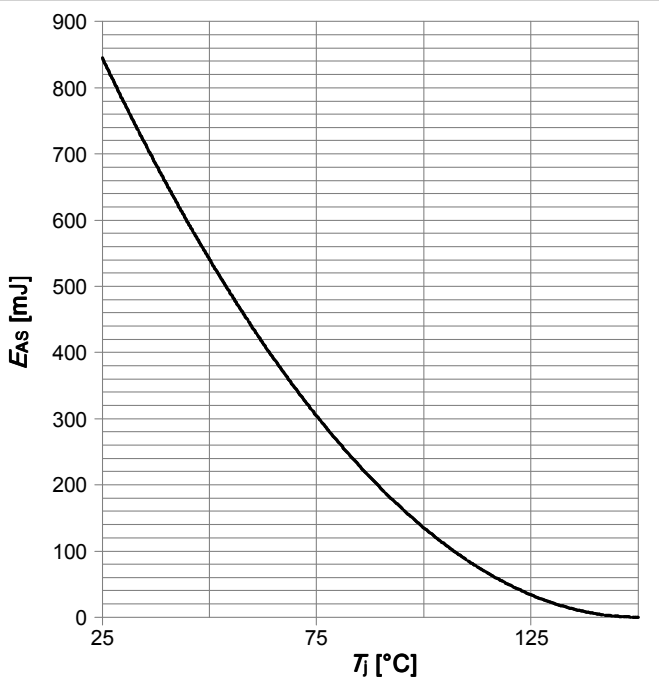
Typ. forward characteristics of reverse diode	Avalanche energy
	
I_F=f(V_{SD}); parameter: T_j	E_{AS}=f(T_j); I_D=6.6 A; V_{DD}=50 V

Table 15

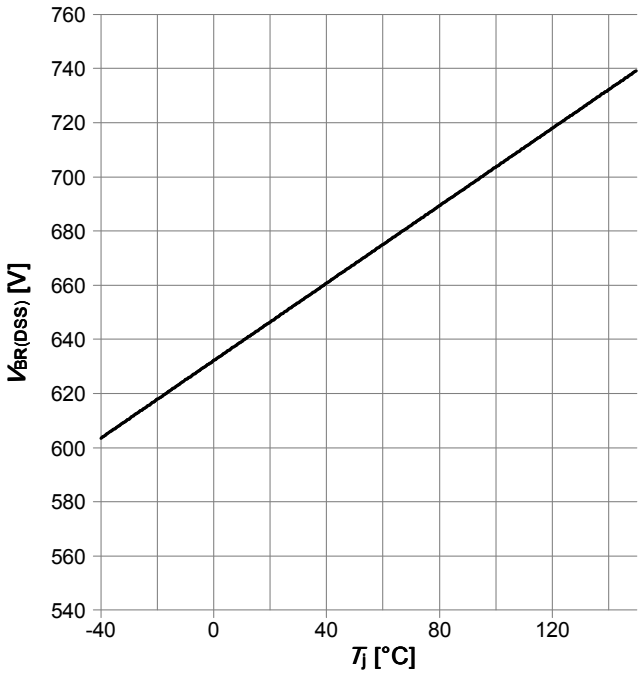
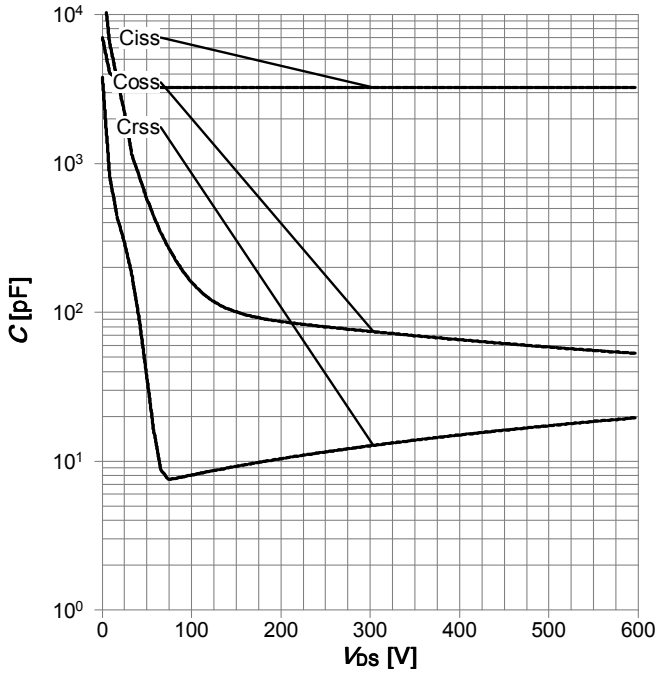
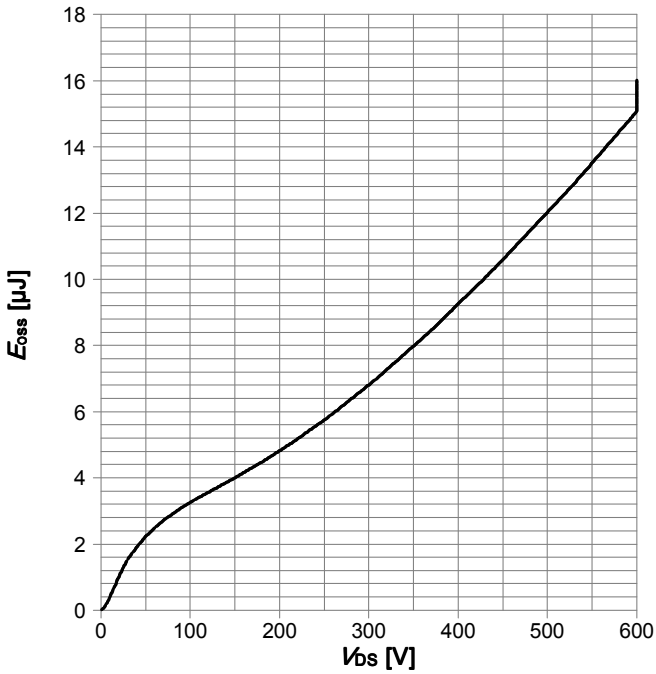
Drain-source breakdown voltage	Typ. capacitances
	
$V_{BR(DSS)}$=f(T_j); I_D=0.25 mA	C=f(V_{DS}); V_{GS}=0 V; f=1 MHz

Table 16

Typ. Coss stored energy

E_{oss}=f(V_{DS})

6 Test Circuits

Table 17 Diode characteristics

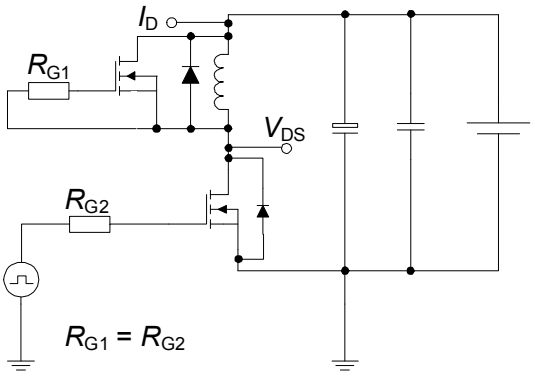
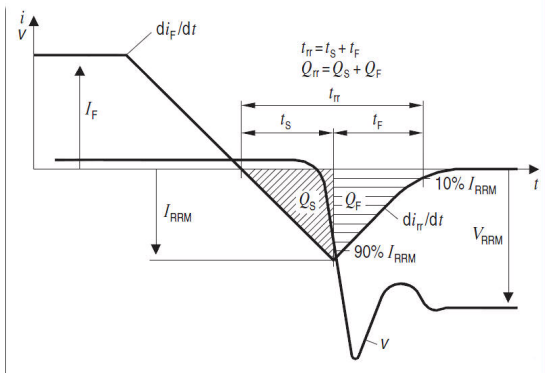
Test circuit for diode characteristics	Diode recovery waveform
	

Table 18 Switching times

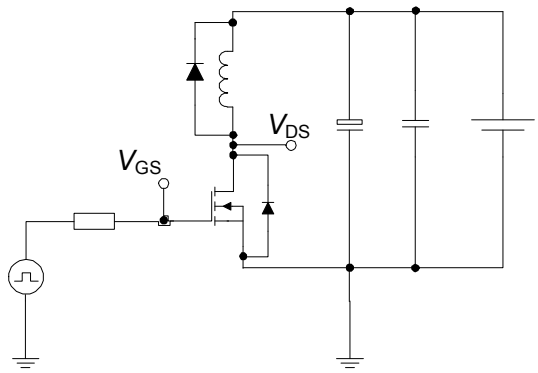
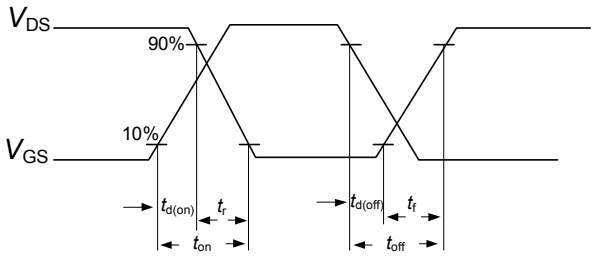
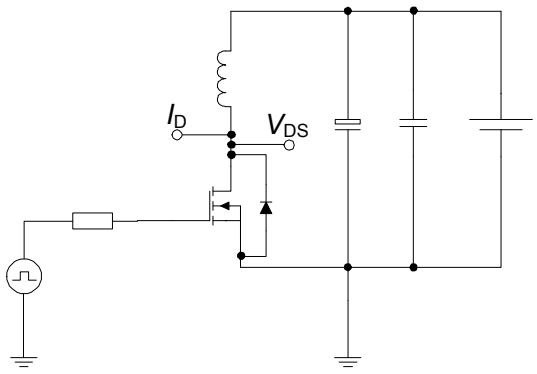
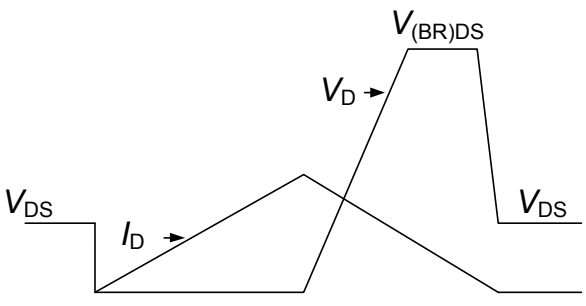
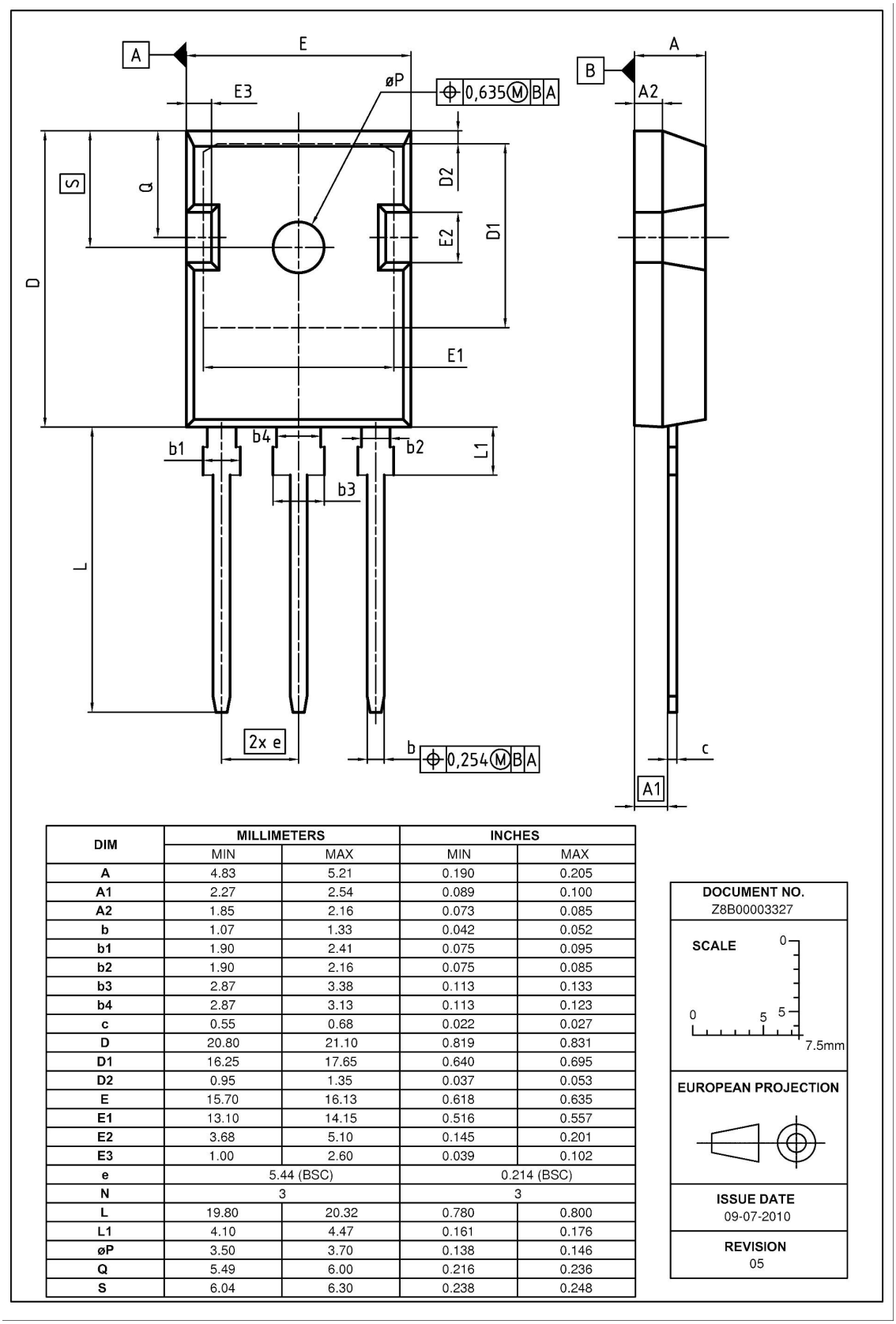
Switching times test circuit for inductive load	Switching times waveform
	

Table 19 Unclamped inductive

Unclamped inductive load test circuit	Unclamped inductive waveform
	

7 Package Outlines



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.83	5.21	0.190	0.205
A1	2.27	2.54	0.089	0.100
A2	1.85	2.16	0.073	0.085
b	1.07	1.33	0.042	0.052
b1	1.90	2.41	0.075	0.095
b2	1.90	2.16	0.075	0.085
b3	2.87	3.38	0.113	0.133
b4	2.87	3.13	0.113	0.123
c	0.55	0.68	0.022	0.027
D	20.80	21.10	0.819	0.831
D1	16.25	17.65	0.640	0.695
D2	0.95	1.35	0.037	0.053
E	15.70	16.13	0.618	0.635
E1	13.10	14.15	0.516	0.557
E2	3.68	5.10	0.145	0.201
E3	1.00	2.60	0.039	0.102
e	5.44 (BSC)		0.214 (BSC)	
N	3		3	
L	19.80	20.32	0.780	0.800
L1	4.10	4.47	0.161	0.176
øP	3.50	3.70	0.138	0.146
Q	5.49	6.00	0.216	0.236
S	6.04	6.30	0.238	0.248

DOCUMENT NO.
Z8B00003327

SCALE
0 5 5 7.5mm

EUROPEAN PROJECTION

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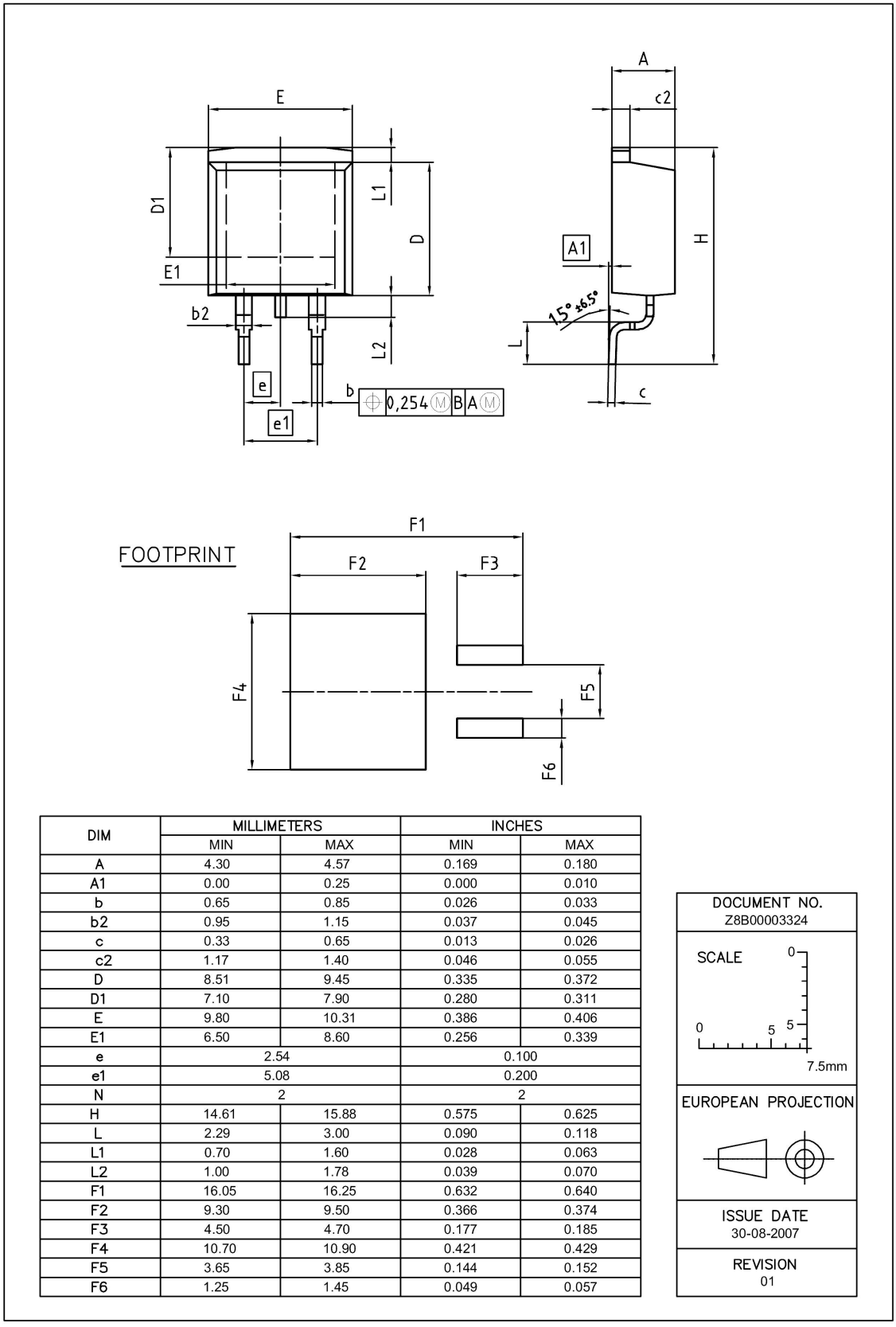
REVISION
05

Figure 1 Outline PG-TO 247, dimensions in mm/inches



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.30	4.57	0.169	0.180
A1	0.00	0.25	0.000	0.010
b	0.65	0.85	0.026	0.033
b2	0.95	1.15	0.037	0.045
c	0.33	0.65	0.013	0.026
c2	1.17	1.40	0.046	0.055
D	8.51	9.45	0.335	0.372
D1	7.10	7.90	0.280	0.311
E	9.80	10.31	0.386	0.406
E1	6.50	8.60	0.256	0.339
e	2.54		0.100	
e1	5.08		0.200	
N	2		2	
H	14.61	15.88	0.575	0.625
L	2.29	3.00	0.090	0.118
L1	0.70	1.60	0.028	0.063
L2	1.00	1.78	0.039	0.070
F1	16.05	16.25	0.632	0.640
F2	9.30	9.50	0.366	0.374
F3	4.50	4.70	0.177	0.185
F4	10.70	10.90	0.421	0.429
F5	3.65	3.85	0.144	0.152
F6	1.25	1.45	0.049	0.057

DOCUMENT NO.
Z8B00003324

SCALE 0 5 5 0 7.5mm

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30-08-2007

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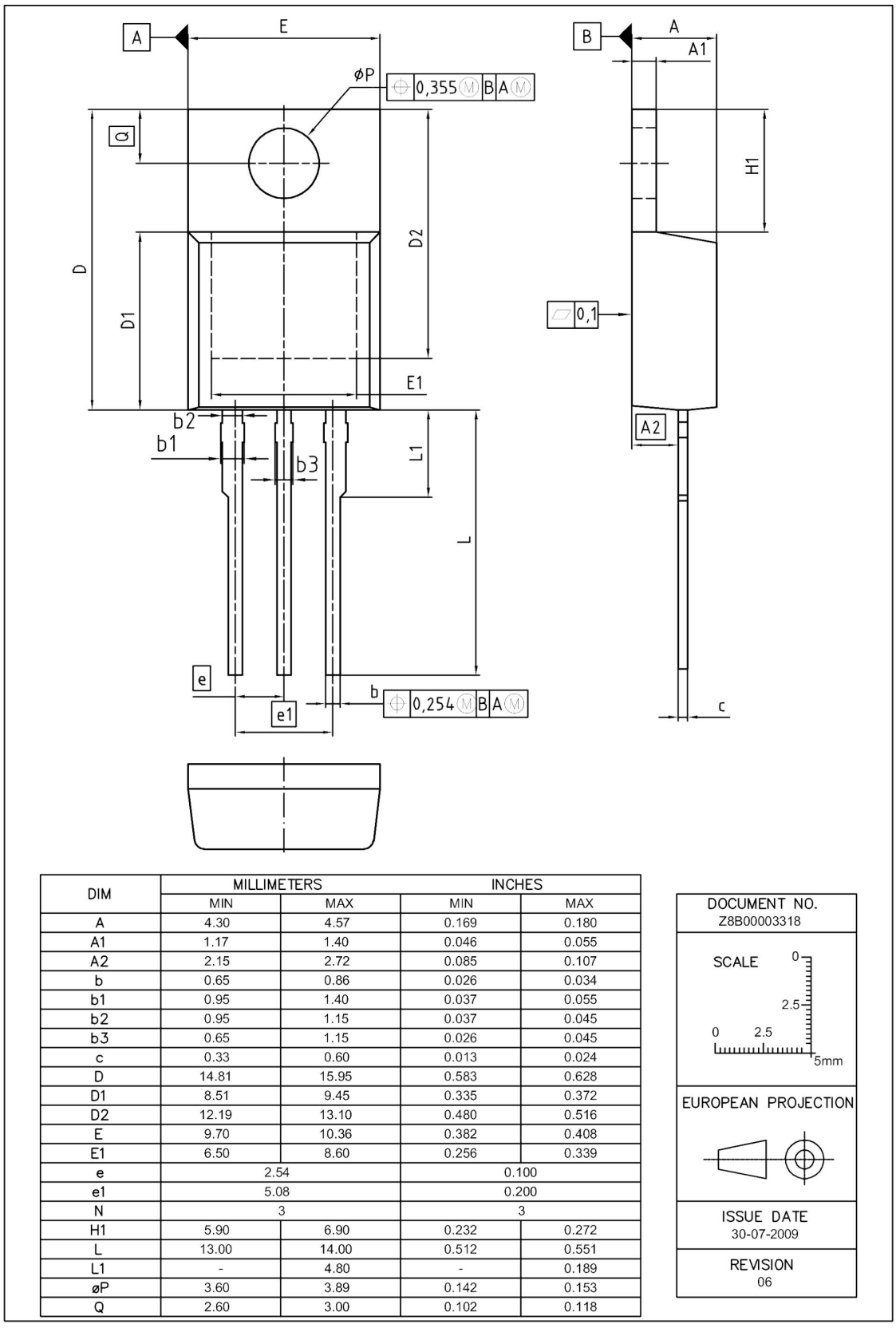
Figure 2 Outline PG-TO 263, dimensions in mm/inches



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.30	4.57	0.169	0.180
A1	1.17	1.40	0.046	0.055
A2	2.15	2.72	0.085	0.107
b	0.65	0.86	0.026	0.034
b1	0.95	1.40	0.037	0.055
b2	0.95	1.15	0.037	0.045
b3	0.65	1.15	0.026	0.045
c	0.33	0.60	0.013	0.024
D	14.81	15.95	0.583	0.628
D1	8.51	9.45	0.335	0.372
D2	12.19	13.10	0.480	0.516
E	9.70	10.36	0.382	0.408
E1	6.50	8.60	0.256	0.339
e	2.54		0.100	
e1	5.08		0.200	
N	3		3	
H1	5.90	6.90	0.232	0.272
L	13.00	14.00	0.512	0.551
L1	-	4.80	-	0.189
øP	3.60	3.89	0.142	0.153
Q	2.60	3.00	0.102	0.118

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SCALE 0 2.5 0 2.5 5mm

EUROPEAN PROJECTION

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REVISION
06

Figure 3 Outline PG-TO 220, dimensions in mm/inches

Revision History

IPW65R110CFDA, IPB65R110CFDA, IPP65R110CFDA

Revision: 2012-03-28, Rev. 2.0

Previous Revision		
Revision	Date	Subjects (major changes since last revision)
2.0	2012-03-28	Final datasheet

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